



# 1.0W SURFACE MOUNT POWER ZENER DIODE POWERDI123

#### **Features**

- 1W Power Dissipation on FR-4 PCB
- Large, Exposed Pad and Heat Sink Designed for Superior Thermal Performance
- Patented Interlocking Clip Design for High-Surge Capacity, US Patent #7,095,113
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>123
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 © 3
- Weight: 0.01 grams (Approximate)



Top View

### Ordering Information (Note 5)

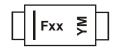
Part Number	Qualification	Case	Packaging
(Type Number)Q-7*	Automotive	PowerDI®123	3000/Tape & Reel

<sup>\*</sup> Add "-7" to the appropriate type number in Electrical Characteristics Table. Example: 6.2V Zener = DFLZ6V2Q-7

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



Fxx = Product Type Marking Code (See Electrical Characteristics Table) YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

#### Date Code Key

Year	2014	2015	5 20	16 20	)17	2018	2019	2020		2021	2022	2023	2024	2025
Code	В	С		)	E	F	G	Н		I	J	K	L	М
Mon	th	Jan	Feb	Mar	Арі	r Ma	ay Ju	n	Jul	Aug	Sep	Oct	Nov	Dec
Cod	е	1	2	3	4	5	6	;	7	8	9	0	N	D



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Forward Voltage	@ $I_F = 200 mA$	$V_{F}$	1.2	V

## **Thermal Characteristics**

Characteristic	Symbol	Тур	Value	Unit
Power Dissipation (Note 6)	$P_{D}$	_	1.0	W
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	110	_	°C/W
Thermal Resistance Junction to Soldering Point (Note 7)	$R_{ heta}$ JS	_	9	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	_	-55 to +150	°C

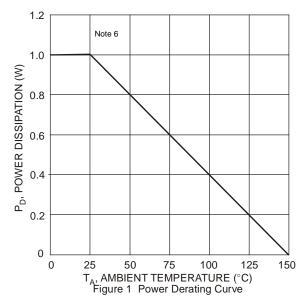
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Туре	Marking	<b>0</b>				Zener Impedance (Note 9)		Maximum Reverse Current (Note 8)		Temperature Coefficient @ I <sub>ZTC</sub>	
Number Codes		V <sub>Z</sub> @ I <sub>ZT</sub>			I <sub>ZT</sub>	Z <sub>ZT</sub> @ I <sub>ZT</sub>		I <sub>R</sub>	@ V <sub>R</sub>	@ V <sub>R</sub> %/°C	
		Nom (V)	Min (V)	Max (V)	mΑ	Typ (Ω)	Max (Ω)	μΑ	٧	Min	Max
DFLZ5V1Q	FHK	5.1	4.8	5.4	100	2	6	2.5	1	-0.08	0.02
DFLZ5V6Q	FHL	5.6	5.2	6.0	100	1	4	10	2	-0.04	0.04
DFLZ6V2Q	FHN	6.2	5.8	6.6	100	1	3	5	2	-0.01	0.06
DFLZ6V8Q	FHO	6.8	6.4	7.2	100	1	3	5	3	0	0.07
DFLZ7V5Q	FHQ	7.5	7.0	7.9	100	1	2	5	3	0	0.07
DFLZ8V2Q	FHR	8.2	7.7	8.7	100	1	2	5	3	0.03	0.08
DFLZ9V1Q	FHT	9.1	8.5	9.6	50	1	4	5	5	0.03	80.0
DFLZ10Q	FHU	10	9.4	10.6	50	1	4	5	7.5	0.05	0.09
DFLZ11Q	FHV	11	10.4	11.6	50	1	7	4	8.2	0.05	0.10
DFLZ12Q	FHW	12	11.4	12.7	50	1	7	3	9.1	0.05	0.10
DFLZ13Q	FHX	13	12.4	14.1	50	1	10	2	10	0.05	0.10
DFLZ15Q	FHZ	15	13.8	15.6	50	1	10	1	11	0.05	0.10
DFLZ16Q	FJA	16	15.3	17.1	25	1	15	1	12	0.06	0.11
DFLZ18Q	FJF	18	16.8	19.1	25	2	15	1	13	0.06	0.11
DFLZ20Q	FJG	20	18.8	21.2	25	3	15	1	15	0.06	0.11
DFLZ22Q	FJK	22	20.8	23.3	25	3	15	1	16	0.06	0.11
DFLZ24Q	FJL	24	22.8	25.6	25	2	15	1	18	0.06	0.11
DFLZ27Q	FJN	27	25.1	28.9	25	3	15	1	20	0.06	0.11
DFLZ30Q	FJQ	30	28	32	25	8	15	1	22	0.06	0.11
DFLZ33Q	FJR	33	31	35	25	5	15	1	24	0.06	0.11
DFLZ36Q	FJS	36	34	38	10	5	40	1	27	0.06	0.11
DFLZ39Q	FJT	39	37	41	10	5	40	1	30	0.06	0.11

Notes:

- 6. Device mounted on 1.5"  $\times$  1.5", FR-4 PCB; 2 oz. Cu with 1"  $\times$  1" pad layout.
- $7. \ Theoretical \ R_{\theta JS} \ calculated \ from \ the \ top \ center \ of \ the \ die \ straight \ down \ to \ the \ PCB/cathode \ tab \ solder \ junction.$
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. The Zener impedance (Zzt) is measured by superimposing a minute alternating current on the regulated current (lzt).





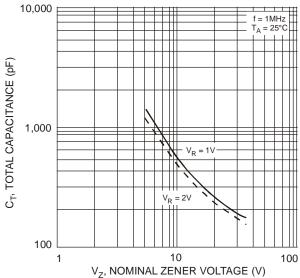
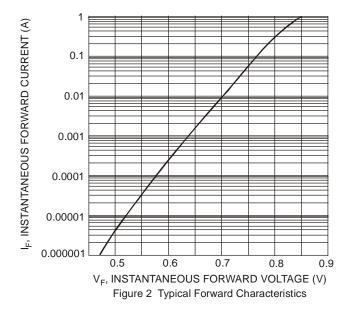


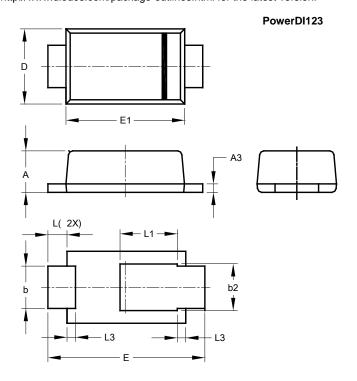
Figure 3 Typical Total Capacitance vs. Nominal Zener Voltage





# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

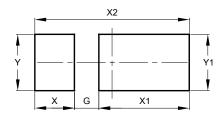


PowerDI123							
Dim	Min	Max	Тур				
Α	0.93	1.00	0.98				
A3	0.15	0.25	0.20				
b	0.85	1.25	1.00				
b2	1.025	1.125	1.10				
D	1.63	1.93	1.78				
Е	3.50	3.90	3.70				
E1	2.60	3.00	2.80				
L	0.40	0.50	0.45				
L1	1.25	1.40	1.35				
L3	0.125	0.275	0.20				
All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI123



Dimensions	Value (in mm)
G	0.65
Х	1.05
X1	2.40
X2	4.10
Υ	1.50
Y1	1.50



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